

DATA SHEET

GENERAL PURPOSE CHIP RESISTORS

RC0805 (Pb Free) 5%; 1%



YAGEO

Product specification – Sep 03, 2004 V.2





Chip Resistor Surface Mount

: |

SERIES

0805 (Pb Free)

SCOPE

This specification describes RC0805 series chip resistors with lead-free terminations made by thick film process.

ORDERING INFORMATION

Part number is identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO ORDERING CODE

CTC CODE

RC0805 $\underline{X} \underline{X} \underline{X} \underline{X} \underline{XX} \underline{XXXX} \underline{L}$

(1) (2) (3) (4) (5)

(I) TOLERANCE

 $F = \pm 1\%$ $J = \pm 5\%$

(2) PACKAGING TYPE

R = Paper/PE taping reel

(3) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(4) TAPING REEL

07 = 7 inch dia. Reel

10 = 10 inch dia. Reel (not preferred)

13 = 13 inch dia, Reel

(5) RESISTANCE VALUE

5R6, 56R, 560R, 5K6, 56K, 22M.

(6) RESISTOR TERMINATIONS

L = Lead free terminations (pure Tin)

ORDERING EXAMPLE

The ordering code of a RC0805 chip resistor, value 56 Ω with ±1% tolerance, supplied in 7-inch tape reel is: RC0805FR-0756RL.

NOTE

- The "L" at the end of the code is only for ordering. On the reel label, the standard CTC will be mentioned an additional stamp "LFP"= lead free production.
- Products with lead in terminations fulfil the same requirements as mentioned in this datasheet.
- 3. Products with lead in terminations will be phased out in the coming months (before July 1st, 2006)





Chip Resistor Surface Mount RO

SERIES

0805 (Pb Free)

MARKING

RC0805



E-24 series: 3 digits

First two digits for significant figure and 3rd digit for number of zeros



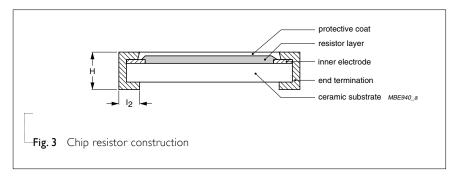
Both E-24 and E-96 series: 4 digits

First three digits for significant figure and 4th digit for number of zeros

For marking codes, please see EIA-marking code rules in data sheet "Chip resistors instruction".

CONSTRUCTION

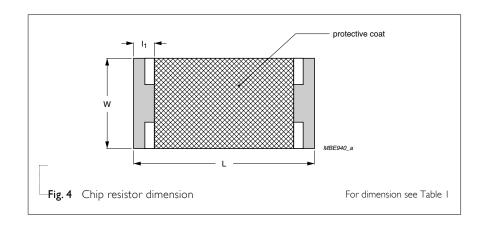
The resistors are constructed out of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive paste. The composition of the paste is adjusted to give the approximate required resistance and laser cutting of this resistive layer that achieves tolerance trims the value. The resistive layer is covered with a protective coat and printed with the



resistance value. Finally, the two external terminations (pure Tin) are added. See fig. 3.

DIMENSIONS

Table I	
TYPE	RC0805
L (mm)	2.00 ±0.10
W (mm)	1.25 ±0.10
H (mm)	0.50 ±0.10
I _I (mm)	0.35 ±0.20
l ₂ (mm)	0.35 ±0.20
-	





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ELECTRICAL CHARACTERISTICS

Table 2

CHARACTERISTICS	F	RC0805 1/8 W
Operating Temperature Range	-55	°C to +155 °C
Maximum Working Voltage		150 V
Maximum Overload Voltage		300 V
Dielectric Withstanding Voltage		300 V
	5% (E24)	I Ω to 22 M Ω
Resistance Range	1% (E96)	I Ω to I0 M Ω
	Zero Ohm Ju	imper < 0.05 Ω
Temperature Coefficient	$10 \Omega < R \le 10 M\Omega$	±100 ppm/°C
	$R \le 10 \Omega$; $R > 10 M\Omega$	±200 ppm/°C
Jumper Criteria	Rated Current	2.0 A
jumper Criteria	Maximum Current	5.0 A

<u>FOOTPRINT AND SOLDERING</u> <u>PROFILES</u>

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

ENVIRONMENTAL DATA

For material declaration information (IMDS-data) of the products, please see the separated info "Environmental data".

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PRODUCT TYPE	PACKING STYLE	REEL DIMENSION	QUANTITY PER REEL
RC0805	Paper / PE Taping Reel (R)	7" (178 mm)	5,000 units
		10" (254 mm) / not preferred	10,000 units
		13" (330 mm)	20,000 units

NOTE

1. For Paper/PE tape and reel specification/dimensions, please see the special data sheet "Packing" document.

FUNCTIONAL DESCRIPTION

POWER RATING

RC0805 rated power at 70°C is 1/8 W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

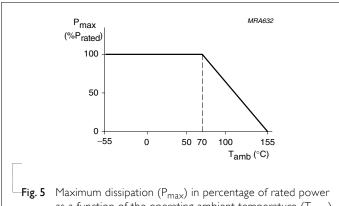
$$V=\sqrt{(P \times R)}$$

Where

V=Continuous rated DC or AC (rms) working voltage (V)

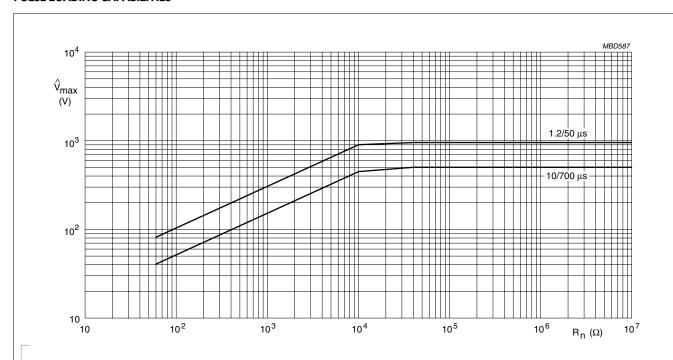
P=Rated power (W)

R=Resistance value (Ω)



as a function of the operating ambient temperature (T_{amb})

PULSE LOADING CAPABILITIES



Maximum permissible peak pulse voltage without failing to open circuit' in accordance with DIN IEC 60040 (CO) 533 for type: RC0805

pulse and repetitive pulse tp/ti = 1000

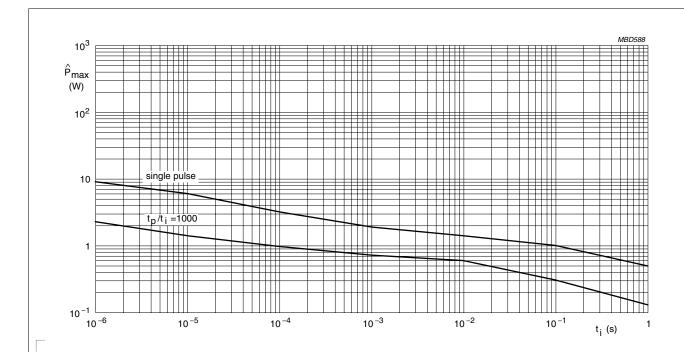
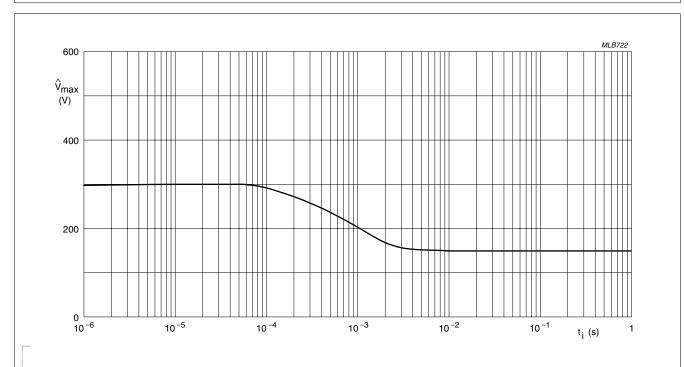


Fig. 7 Pulse on a regular basis for type: RC0805; maximum permissible peak pulse power as a function of pulse duration for single





TESTS AND REQUIREMENTS

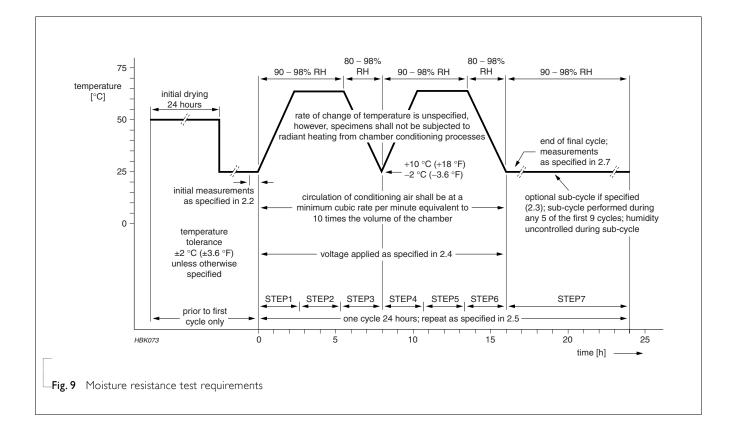
Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature	MIL-STD-202F-method 304;	At +25/–55 °C and +25/+125 °C	Refer to table 3
Coefficient of Resistance	JIS C 5202-4.8	Formula:	
(T.C.R.)			
		T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where t_1 =+25 °C or specified room temperature	
	t_2 =–55 °C or +125 °C test temperature		
		R_1 =resistance at reference temperature in ohms	
		R ₂ =resistance at test temperature in ohms	
Thermal Shock	MIL-STD-202F-method I07G;	At -65 (+0/-10) °C for 2 minutes and at +155	$\pm (0.5\% + 0.05~\Omega)$ for 1% tol.
	IEC 60115-1 4.19	(+10/−0) °C for 2 minutes; 25 cycles	$\pm (1.0\% {+} 0.05~\Omega)$ for 5% tol.
Low	MIL-R-55342D-Para 4.7.4	At -65 (+0/-5) °C for I hour, RCWV applied	$\pm (0.5\% + 0.05~\Omega)$ for 1% tol .
Temperature		for 45 (+5/–0) minutes	$\pm (1.0\% {+} 0.05~\Omega)$ for 5% tol.
Operation			No visible damage
Short Time	MIL-R-55342D-Para 4.7.5;	2.5 × RCWV applied for 5 seconds at room	\pm (1.0%+0.05 Ω) for 1% tol.
Overload	IEC 60115-1 4.13	temperature	$\pm (2.0\% + 0.05~\Omega)$ for 5% tol.
			No visible damage
Insulation	MIL-STD-202F-method 302;	RCOV for 1 minute	≥10 GΩ
Resistance	IEC 60115-1 4.6.1.1	Type RC0805	
		Voltage (DC) 300 V	
Dielectric	MIL-STD-202F-method 301;	Maximun voltage (V _{rms}) applied for 1 minute	No breakdown or flashover
Withstand Voltage	IEC 60115-1 4.6.1.1	Type RC0805	
		Voltage (AC) 300 V _{rms}	
		volume (1.0)	
Resistance to Soldering Heat	MIL-STD-202F-method 210C;	Unmounted chips; 260 \pm 5 °C for 10 \pm 1	$\pm (0.5\% + 0.05~\Omega)$ for 1% tol.
	IEC 60115-1 4.18	seconds	\pm (1.0%+0.05 Ω) for 5% tol.
			No visible damage
Life	MIL-STD-202F-method 108A;	At 70±2 °C for 1,000 hours; RCWV applied for	$\pm (1\% + 0.05 \ \Omega)$ for 1% tol.
	IEC 60115-1 4.25.1	1.5 hours on and 0.5 hour off	$\pm (3\% + 0.05 \ \Omega)$ for 5% tol.



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-202F-method 208A; 5-1 4.17 02.6.14; 15-1 4.15 0-202F-method 215; 15-1 4.29 02 5.9; 15-1 4.12	Solder bath at 245±3 °C Dipping time: 2±0.5 seconds Resistors mounted on a 90 mm glass epoxy resin PCB (FR4) Bending: 5 mm Isopropylalcohol (C ₃ H ₇ OH) or dichloromethane (CH ₂ Cl ₂) followed by brushing Maximum voltage (V _{rms}) applied.	Well tinned (\geq 95% cover No visible damage $\pm (1.0\% + 0.05~\Omega) \text{ for } 1\%$ $\pm (1.0\% + 0.05~\Omega) \text{ for } 5\%$ $\pm (1.0\% + 0.05~\Omega) \text{ for } 5\%$ $\pm (1.0\% + 0.05~\Omega) \text{ for } 5\%$ No visible damage No smeared No smeared Resistors range $\text{R} < 100~\Omega$ $100~\Omega \leq \text{R} < 1~\text{K}\Omega$ $1~\text{K}\Omega \leq \text{R} < 10~\text{K}\Omega$ $10~\text{K}\Omega \leq \text{R} < 10~\text{K}\Omega$ $10~\text{K}\Omega \leq \text{R} < 1~\text{M}\Omega$ $1~\text{M}\Omega \leq \text{R} \leq 22~\text{M}\Omega$	s tol.
02.6.14; 15-1 4.15 0-202F-method 215; 15-1 4.29 02 5.9;	Resistors mounted on a 90 mm glass epoxy resin PCB (FR4) Bending: 5 mm Isopropylalcohol (C ₃ H ₇ OH) or dichloromethane (CH ₂ Cl ₂) followed by brushing	$\pm (1.0\% + 0.05 \ \Omega) \text{ for } 1\%$ $\pm (1.0\% + 0.05 \ \Omega) \text{ for } 5\%$ No visible damage No smeared $\frac{\text{Resistors range}}{R < 100 \ \Omega}$ $\frac{100 \ \Omega \leq R < 1 \ K\Omega}{I \ K\Omega \leq R < 100 \ K\Omega}$ $\frac{100 \ K\Omega \leq R < 1 \ M\Omega}{I \ M\Omega}$	Value 10 dB 20 dB 30 dB 40 dB 46 dB
D-202F-method 215; 15-1 4.29 02 5.9;	resin PCB (FR4) Bending: 5 mm Isopropylalcohol (C ₃ H ₇ OH) or dichloromethane (CH ₂ Cl ₂) followed by brushing	$\pm (1.0\% + 0.05 \ \Omega) \text{ for } 5\%$ No visible damage No smeared Resistors range $R < 100 \ \Omega$ $100 \ \Omega \le R < 1 \ K\Omega$ $1 \ K\Omega \le R < 100 \ K\Omega$ $100 \ K\Omega \le R < 1 \ M\Omega$	Value 10 dB 20 dB 30 dB 40 dB 46 dB
D-202F-method 215; 15-1 4.29 02 5.9;	resin PCB (FR4) Bending: 5 mm Isopropylalcohol (C ₃ H ₇ OH) or dichloromethane (CH ₂ Cl ₂) followed by brushing	No visible damage No smeared Resistors range $R < 100 \Omega$ $100 \Omega \le R < 1 K\Omega$ $1 K\Omega \le R < 100 K\Omega$ $10 K\Omega \le R < 100 K\Omega$ $100 K\Omega \le R < 1 M\Omega$	Value 10 dB 20 dB 30 dB 40 dB 46 dB
15-1 4.29 02 5.9;	Isopropylalcohol (C_3H_7OH) or dichloromethane (CH_2Cl_2) followed by brushing	No smeared	10 dB 20 dB 30 dB 40 dB 46 dB
15-1 4.29 02 5.9;	(CH ₂ Cl ₂) followed by brushing	Resistors range $R < 100 \Omega$ $100 \Omega \le R < 1 K\Omega$ $1 K\Omega \le R < 10 K\Omega$ $10 K\Omega \le R < 100 K\Omega$ $100 K\Omega \le R < 1 M\Omega$	10 dB 20 dB 30 dB 40 dB 46 dB
02 5.9;		$R < 100 \Omega$ $100 \Omega \le R < 1 K\Omega$ $1 K\Omega \le R < 10 K\Omega$ $10 K\Omega \le R < 100 K\Omega$ $100 K\Omega \le R < 1 M\Omega$	10 dB 20 dB 30 dB 40 dB 46 dB
	Maximum voltage (V _{rms}) applied.	$R < 100 \Omega$ $100 \Omega \le R < 1 K\Omega$ $1 K\Omega \le R < 10 K\Omega$ $10 K\Omega \le R < 100 K\Omega$ $100 K\Omega \le R < 1 M\Omega$	10 dB 20 dB 30 dB 40 dB 46 dB
15-1 4.12		$\begin{aligned} & 100 \ \Omega \leq R < 1 \ K\Omega \\ & 1 \ K\Omega \leq R < 10 \ K\Omega \\ & 10 \ K\Omega \leq R < 100 \ K\Omega \\ & 100 \ K\Omega \leq R < 1 \ M\Omega \end{aligned}$	20 dB 30 dB 40 dB 46 dB
		$\begin{array}{c} I \ K\Omega \leq R < I0 \ K\Omega \\ \\ I0 \ K\Omega \leq R < I00 \ K\Omega \\ \\ I00 \ K\Omega \leq R < I \ M\Omega \end{array}$	30 dB 40 dB 46 dB
		$\frac{10 \text{ K}\Omega \leq \text{R} < 100 \text{ K}\Omega}{100 \text{ K}\Omega \leq \text{R} < 1 \text{ M}\Omega}$	40 dB 46 dB
		$100 \text{ K}\Omega \leq \text{R} < 1 \text{ M}\Omega$	46 dB
		$I M\Omega \le R \le 22 M\Omega$	
02 7.5;	I,000 hours; 40±2 °C; 93(+2/-3)% RH	$\pm (0.5\% + 0.05~\Omega)$ for 1% tol. $\pm (2.0\% + 0.05~\Omega)$ for 5% tol.	
15-8 4.24.8	RCWV applied for 1.5 hours on and 0.5 hour off		
13B;	Solder bath at 260±5 °C	No visible damage	
15-8 4.18	Dipping time: 30±1 seconds		
02 5.8	At room temperature; 2.5 × RCWV applied for I second on and 25 seconds off; total 10,000 cycles	\pm (1.0%+0.05 Ω) for 1% tol. \pm (2.0%+0.05 Ω) for 5% tol.	
est	On request		
D-202F-method 106F	42 cycles; total 1,000 hours	\pm (0.5%+0.05Ω) for 1%	tol.
,	Shown as figure 9	$\pm (2.0\% + 0.05\Omega)$ for 5% tol. No visible damage	
15-1 4.24.2			
	D-202F-method 106F;	I second on and 25 seconds off; total 10,000 cycles On request O-202F-method 106F; 42 cycles; total 1,000 hours	I second on and 25 seconds off; total 10,000 $\pm (2.0\% + 0.05 \ \Omega)$ for 5% cycles On request D-202F-method 106F; 42 cycles; total 1,000 hours $\pm (0.5\% + 0.05 \Omega)$ for 1% $\pm (2.0\% + 0.05 \Omega)$ for 5% $\pm (2.0\% + 0.05 \Omega)$ for 5% 15-1 4.24.2 Shown as figure 9







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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 2	Sep 03, 2004	-	- Test method and procedure updated
			- PE tape added (paper tape will be replaced by PE tape)